NEW PRODUCT

## Electrical Characteristics N-CHANNEL – $Q_1$ @$T_A$ = 25°C unless otherwise specified

| Characteristic | Symbol | Min | Typ | Max | Unit | Test Condition |
|---|---|---|---|---|---|---|
| **OFF CHARACTERISTICS (Note 5)** | | | | | | |
| Drain-Source Breakdown Voltage | $BV_{DSS}$ | 20 | — | — | V | $V_{GS}$ = 0V, $I_D$ = 10μA |
| Zero Gate Voltage Drain Current | $I_{DSS}$ | — | — | 1 | μA | $V_{DS}$ = 16V, $V_{GS}$ = 0V |
| Gate-Source Leakage | $I_{GSS}$ | — | — | ± 1 | μA | $V_{GS}$ = ±4.5V, $V_{DS}$ = 0V |
| **ON CHARACTERISTICS (Note 5)** | | | | | | |
| Gate Threshold Voltage | $V_{GS(th)}$ | 0.5 | — | 1.0 | V | $V_{DS}$ = $V_{GS}$, $I_D$ = 250μA |
| Static Drain-Source On-Resistance | $R_{DS\ (ON)}$ | —<br>—<br>— | 0.4<br>0.5<br>0.7 | 0.55<br>0.70<br>0.90 | Ω | $V_{GS}$ = 4.5V, $I_D$ = 540mA<br>$V_{GS}$ = 2.5V, $I_D$ = 500mA<br>$V_{GS}$ = 1.8V, $I_D$ = 350mA |
| Forward Transfer Admittance | $\|Y_{fs}\|$ | 200 | — | — | mS | $V_{DS}$ =10V, $I_D$ = 0.2A |
| Diode Forward Voltage (Note 5) | $V_{SD}$ | 0.5 | — | 1.2 | V | $V_{GS}$ = 0V, $I_S$ = 115mA |
| **DYNAMIC CHARACTERISTICS** | | | | | | |
| Input Capacitance | $C_{iss}$ | — | — | 150 | pF | $V_{DS}$ = 16V, $V_{GS}$ = 0V<br>f = 1.0MHz |
| Output Capacitance | $C_{oss}$ | — | — | 25 | pF | |
| Reverse Transfer Capacitance | $C_{rss}$ | — | — | 20 | pF | |

## Electrical Characteristics P-CHANNEL – $Q_2$ @$T_A$ = 25°C unless otherwise specified

| Characteristic | Symbol | Min | Typ | Max | Unit | Test Condition |
|---|---|---|---|---|---|---|
| **OFF CHARACTERISTICS (Note 5)** | | | | | | |
| Drain-Source Breakdown Voltage | $BV_{DSS}$ | -20 | — | — | V | $V_{GS}$ = 0V, $I_D$ = -250μA |
| Zero Gate Voltage Drain Current | $I_{DSS}$ | — | — | -1.0 | μA | $V_{DS}$ = -20V, $V_{GS}$ = 0V |
| Gate-Source Leakage | $I_{GSS}$ | — | — | ± 1.0 | μA | $V_{GS}$ = ±4.5V, $V_{DS}$ = 0V |
| **ON CHARACTERISTICS (Note 5)** | | | | | | |
| Gate Threshold Voltage | $V_{GS(th)}$ | -0.5 | — | -1.0 | V | $V_{DS}$ = $V_{GS}$, $I_D$ = -250μA |
| Static Drain-Source On-Resistance | $R_{DS\ (ON)}$ | — | 0.7<br>1.1<br>1.7 | 0.9<br>1.4<br>2.0 | Ω | $V_{GS}$ = -4.5V, $I_D$ = -430mA<br>$V_{GS}$ = -2.5V, $I_D$ = -300mA<br>$V_{GS}$ = -1.8V, $I_D$ = -150mA |
| Forward Transfer Admittance | $\|Y_{fs}\|$ | 200 | — | — | mS | $V_{DS}$ =10V, $I_D$ = 0.2A |
| Diode Forward Voltage (Note 5) | $V_{SD}$ | -0.5 | — | -1.2 | V | $V_{GS}$ = 0V, $I_S$ = -115mA |
| **DYNAMIC CHARACTERISTICS** | | | | | | |
| Input Capacitance | $C_{iss}$ | — | — | 175 | pF | $V_{DS}$ = -16V, $V_{GS}$ = 0V<br>f = 1.0MHz |
| Output Capacitance | $C_{oss}$ | — | — | 30 | pF | |
| Reverse Transfer Capacitance | $C_{rss}$ | — | — | 20 | pF | |

Notes: 5. Short duration pulse test used to minimize self-heating effect.

NEW PRODUCT

## $Q_1$, N-CHANNEL

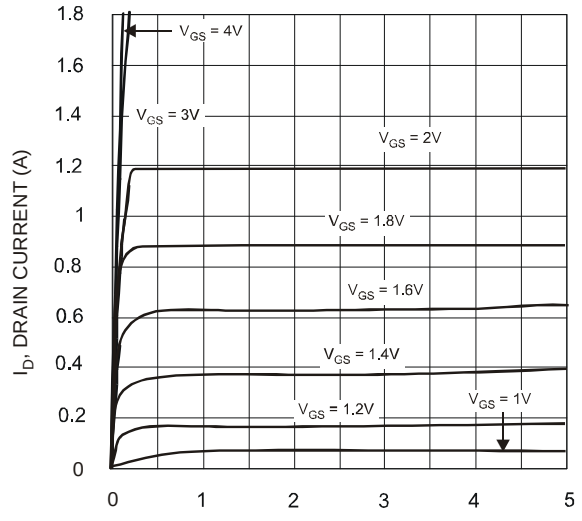



Fig. 1 Typical Output Characteristics

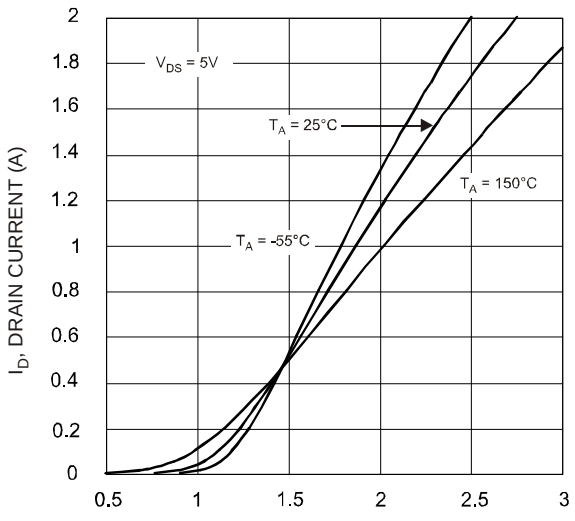



Fig. 2 Typical Transfer Characteristics

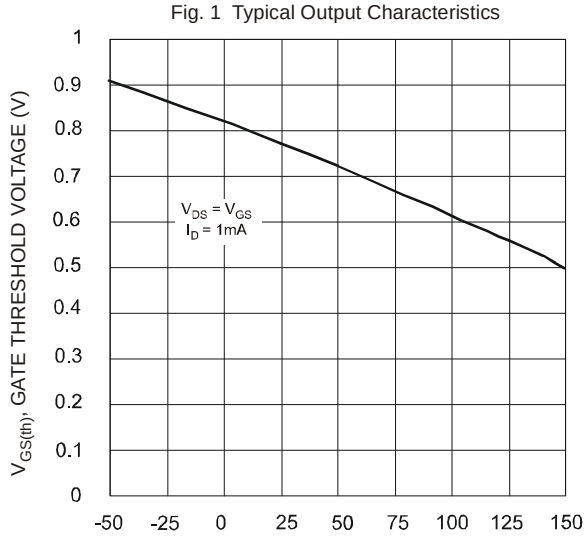



Fig. 3 Gate Threshold Voltage vs. Ambient Temperature

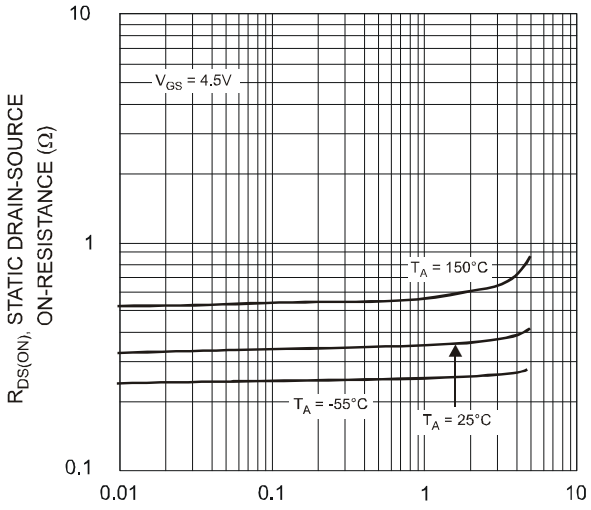



Fig. 4 Static Drain-Source On-Resistance vs. Drain Current

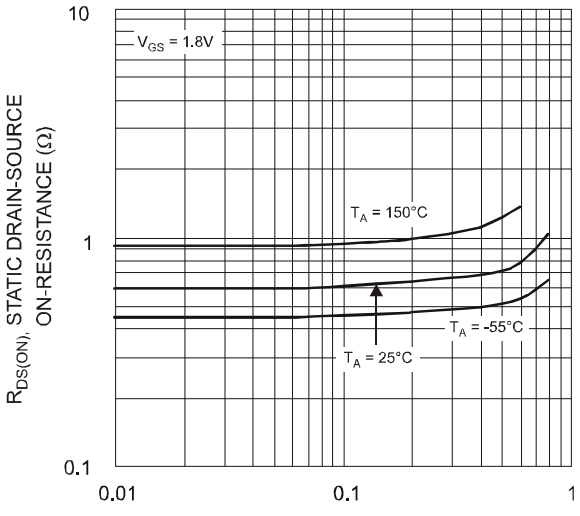



Fig. 5 Static Drain-Source On-Resistance vs. Drain Current

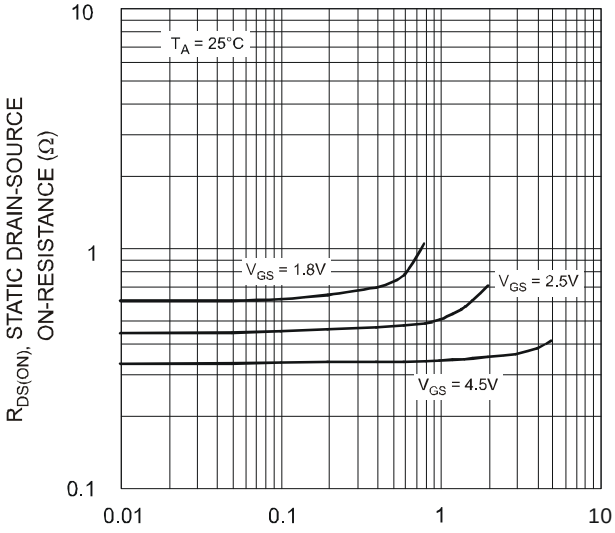



Fig. 6 Static Drain-Source On-Resistance vs. Drain-Source Current vs. Gate Source Voltage

NEW PRODUCT

## $Q_1$, N-CHANNEL (continued)

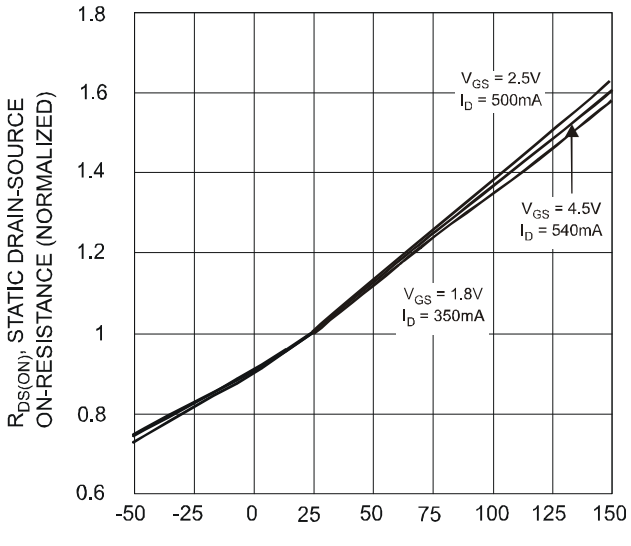



Fig. 7 Static Drain-Source On-State Resistance vs. Ambient Temperature

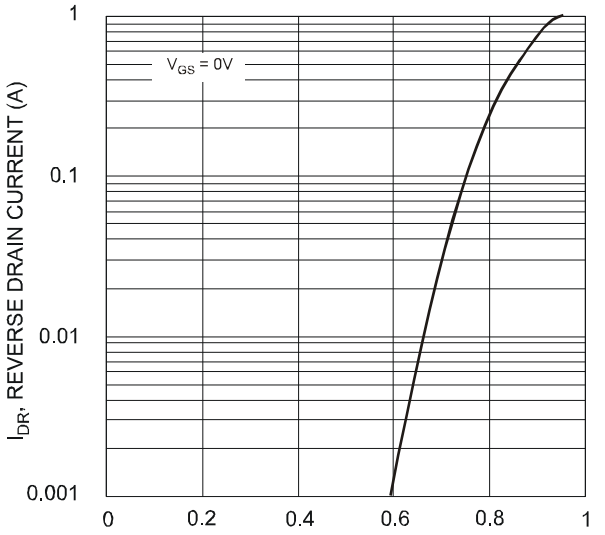



Fig. 8 Reverse Drain Current vs. Source-Drain Voltage

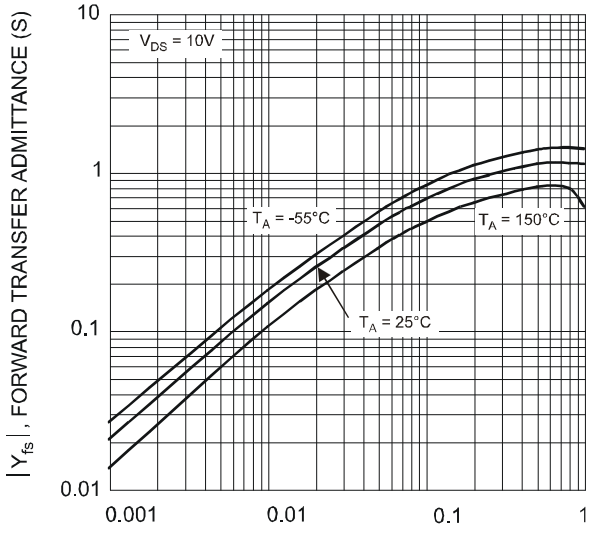



Fig. 9 Forward Transfer Admittance vs. Drain Current

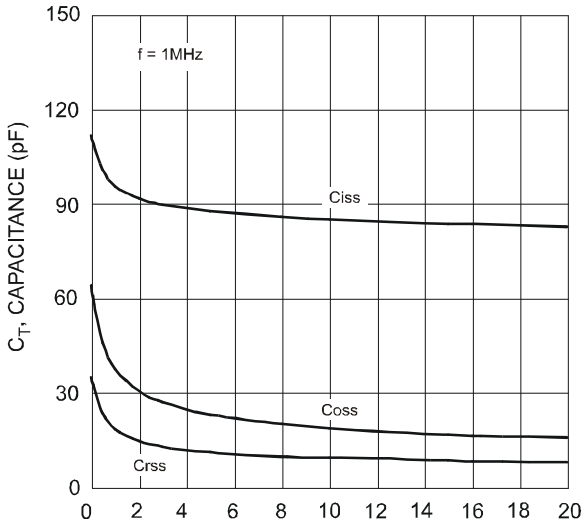



Fig. 10 Typical Capacitance

NEW PRODUCT

## $Q_2$, P-CHANNEL

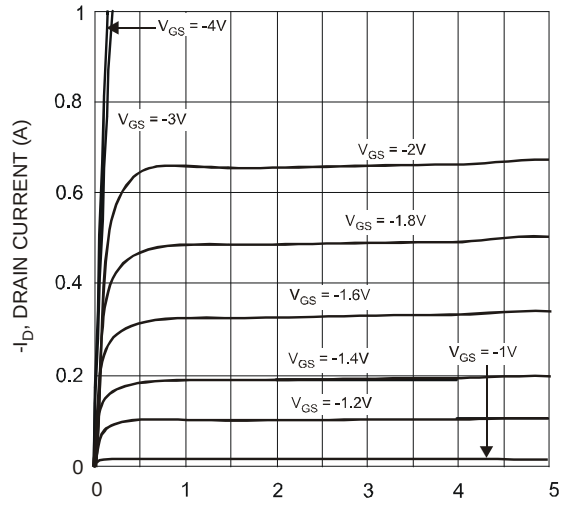



Fig. 11 Typical Output Characteristics

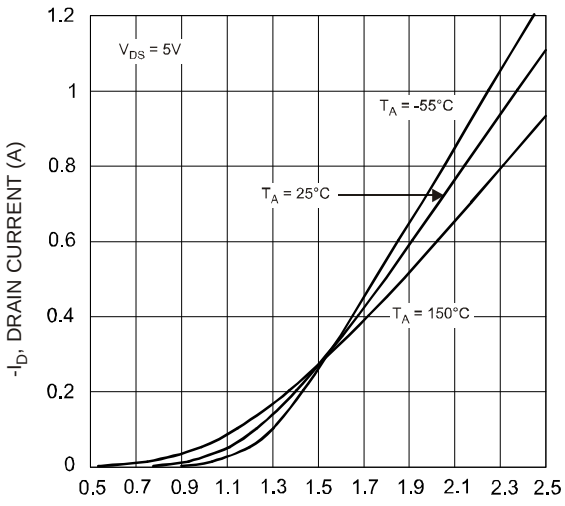



Fig. 12 Typical Transfer Characteristics

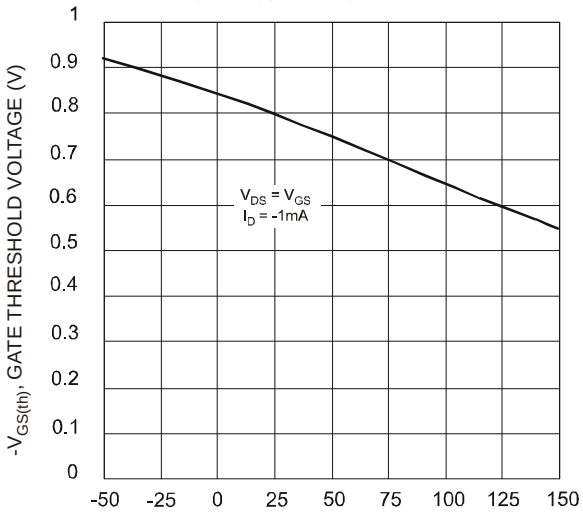



Fig. 13 Gate Threshold Voltage vs. Ambient Temperature

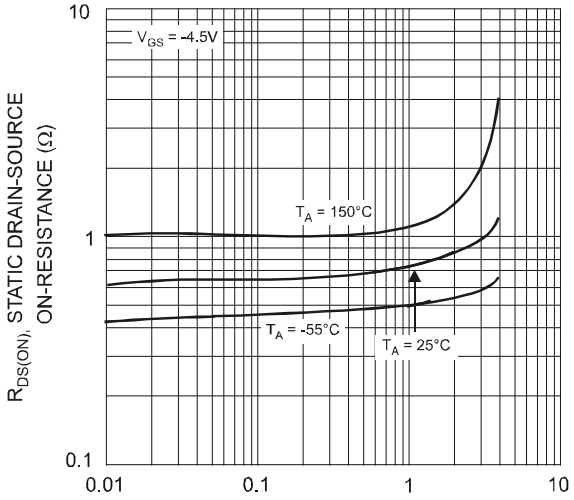



Fig. 14 Static Drain-Source On-Resistance vs. Drain Current

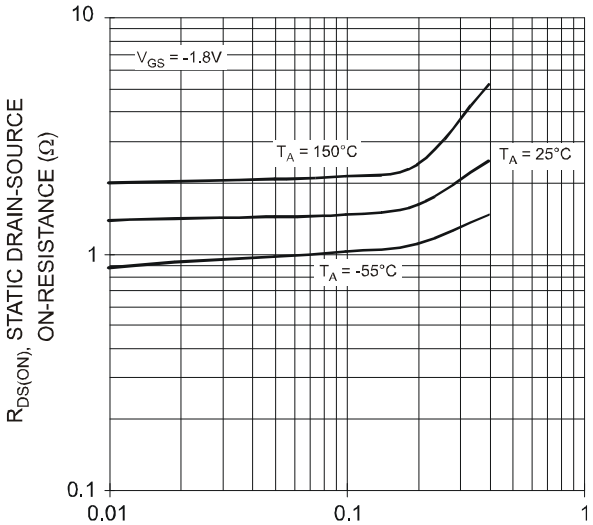



Fig. 15 Static Drain-Source On-Resistance vs. Drain Current

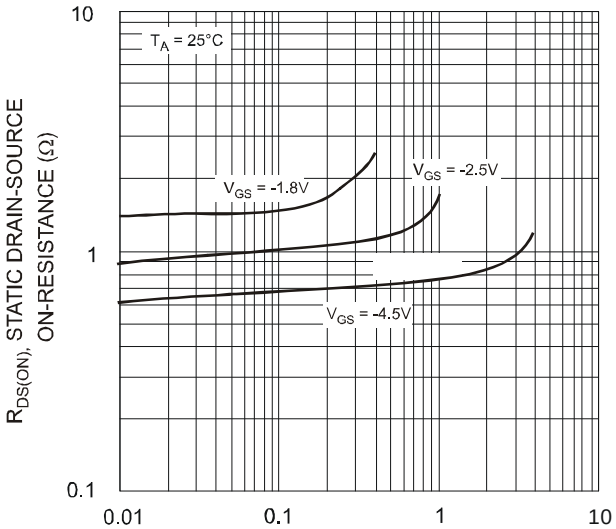



Fig. 16 Static Drain-Source On-Resistance vs. Drain-Source Current vs. Gate Source Voltage

NEW PRODUCT

## $Q_2$, P-CHANNEL (continued)

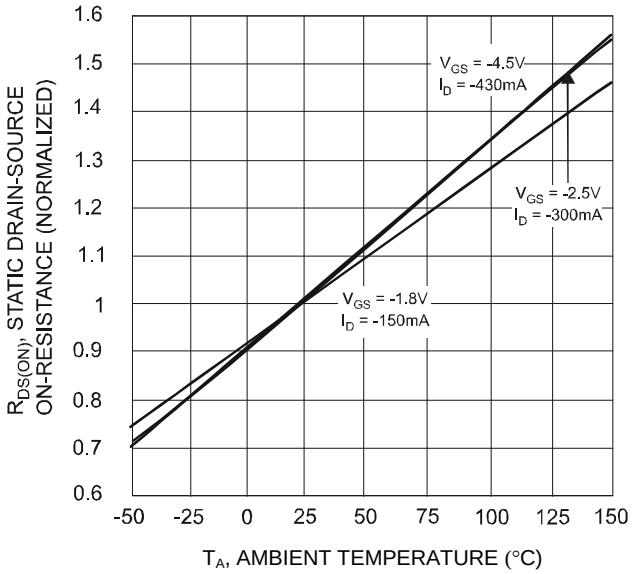



Fig. 17 Static Drain-Source On-State Resistance vs. Ambient Temperature

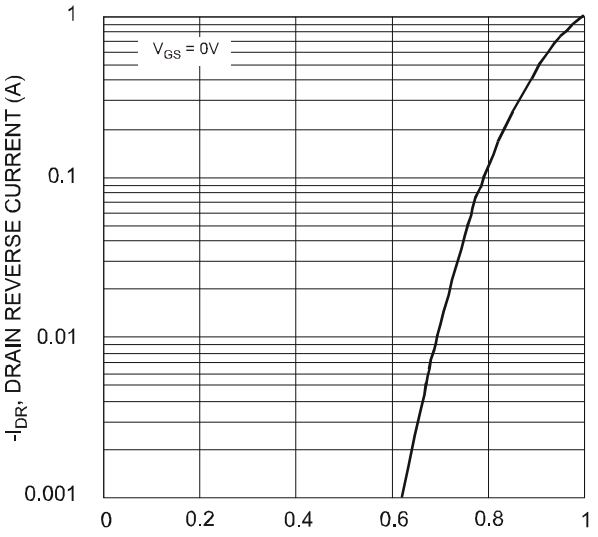



Fig. 18 Reverse Drain Current vs. Source-Drain Voltage

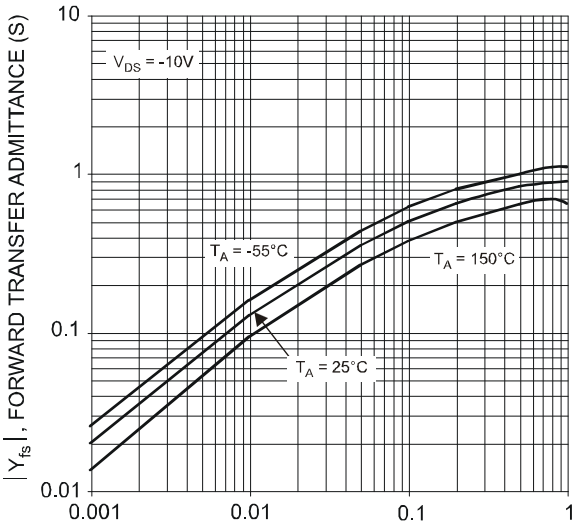



Fig. 19 Forward Transfer Admittance vs. Drain Current

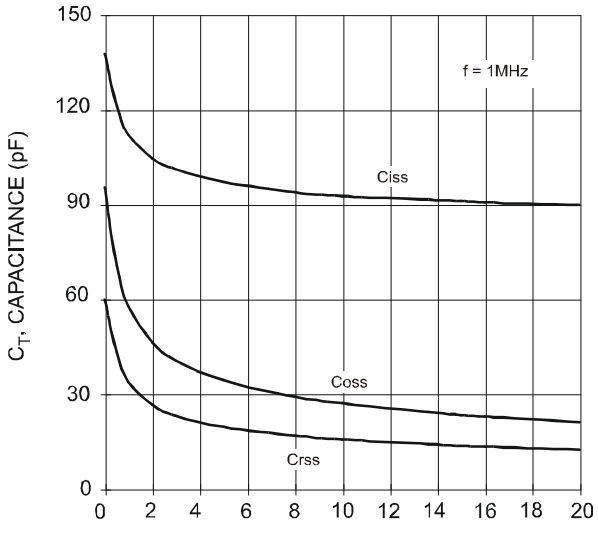



Fig. 20 Typical Capacitance

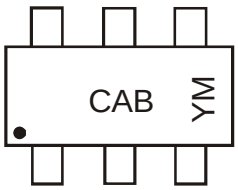
NEW PRODUCT

## Ordering Information (Note 6)

| Part Number | Case | Packaging |
|---|---|---|
| DMC2004DWK-7 | SOT-363 | 3000/Tape & Reel |

Notes: 6. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

## Marking Information




CAB = Marking Code
YM = Date Code Marking
Y = Year ex: U = 2007
M = Month ex: 9 = September

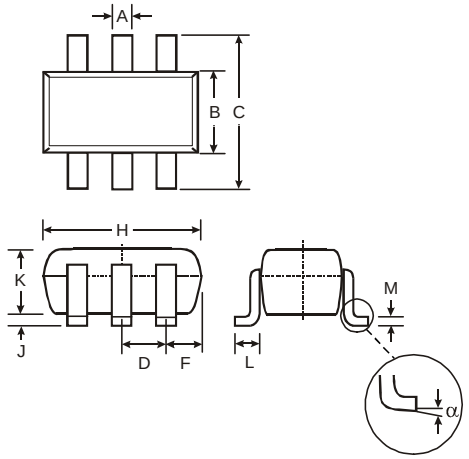
Date Code Key

| Year | 2007 | 2008 | 2009 | 2010 | 2011 | 2012 |
|---|---|---|---|---|---|---|
| Code | U | V | W | X | Y | Z |

| Month | Jan | Feb | Mar | Apr | May | Jun | Jul | Aug | Sep | Oct | Nov | Dec |
|---|---|---|---|---|---|---|---|---|---|---|---|---|
| Code | 1 | 2 | 3 | 4 | 5 | 6 | 7 | 8 | 9 | O | N | D |

## Package Outline Dimensions

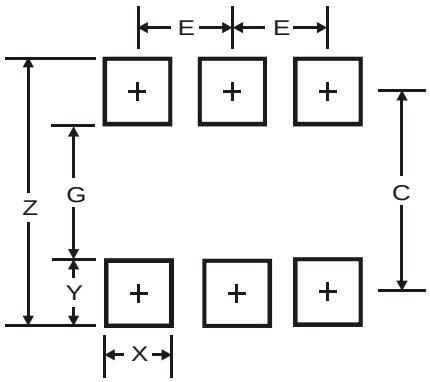
Please see http://www.diodes.com/package-outlines.html for the latest version.




| SOT-363 | | |
|---|---|---|
| Dim | Min | Max |
| A | 0.10 | 0.30 |
| B | 1.15 | 1.35 |
| C | 2.00 | 2.20 |
| D | 0.65 Nominal | |
| F | 0.30 | 0.40 |
| H | 1.80 | 2.20 |
| J | — | 0.10 |
| K | 0.90 | 1.00 |
| L | 0.25 | 0.40 |
| M | 0.10 | 0.25 |
| α | 0° | 8° |
| All Dimensions in mm | | |

## Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.




| Dimensions | Value (in mm) |
|---|---|
| Z | 2.5 |
| G | 1.3 |
| X | 0.42 |
| Y | 0.6 |
| C | 1.9 |
| E | 0.65 |

NEW PRODUCT

**IMPORTANT NOTICE**

DIODES INCORPORATED MAKES NO WARRANTY OF ANY KIND, EXPRESS OR IMPLIED, WITH REGARDS TO THIS DOCUMENT, INCLUDING, BUT NOT LIMITED TO, THE IMPLIED WARRANTIES OF MERCHANTABILITY AND FITNESS FOR A PARTICULAR PURPOSE (AND THEIR EQUIVALENTS UNDER THE LAWS OF ANY JURISDICTION).

Diodes Incorporated and its subsidiaries reserve the right to make modifications, enhancements, improvements, corrections or other changes without further notice to this document and any product described herein. Diodes Incorporated does not assume any liability arising out of the application or use of this document or any product described herein; neither does Diodes Incorporated convey any license under its patent or trademark rights, nor the rights of others. Any Customer or user of this document or products described herein in such applications shall assume all risks of such use and will agree to hold Diodes Incorporated and all the companies whose products are represented on Diodes Incorporated website, harmless against all damages.

Diodes Incorporated does not warrant or accept any liability whatsoever in respect of any products purchased through unauthorized sales channel. Should Customers purchase or use Diodes Incorporated products for any unintended or unauthorized application, Customers shall indemnify and hold Diodes Incorporated and its representatives harmless against all claims, damages, expenses, and attorney fees arising out of, directly or indirectly, any claim of personal injury or death associated with such unintended or unauthorized application.

Products described herein may be covered by one or more United States, international or foreign patents pending. Product names and markings noted herein may also be covered by one or more United States, international or foreign trademarks.

This document is written in English but may be translated into multiple languages for reference. Only the English version of this document is the final and determinative format released by Diodes Incorporated.

**LIFE SUPPORT**

Diodes Incorporated products are specifically not authorized for use as critical components in life support devices or systems without the express written approval of the Chief Executive Officer of Diodes Incorporated. As used herein:

A. Life support devices or systems are devices or systems which:

1. are intended to implant into the body, or
2. support or sustain life and whose failure to perform when properly used in accordance with instructions for use provided in the labeling can be reasonably expected to result in significant injury to the user.

B. A critical component is any component in a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or to affect its safety or effectiveness.

Customers represent that they have all necessary expertise in the safety and regulatory ramifications of their life support devices or systems, and acknowledge and agree that they are solely responsible for all legal, regulatory and safety-related requirements concerning their products and any use of Diodes Incorporated products in such safety-critical, life support devices or systems, notwithstanding any devices- or systems-related information or support that may be provided by Diodes Incorporated. Further, Customers must fully indemnify Diodes Incorporated and its representatives against any damages arising out of the use of Diodes Incorporated products in such safety-critical, life support devices or systems.



**www.diodes.com**